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HMC427LP3 / 427LP3E

GaAs MMIC POSITIVE CONTROL TRANSFER SWITCH, DC* - 8 GHz

ROHS V

Typical Applications

The HMC427LP3 / HMC427LP3E is ideal for:

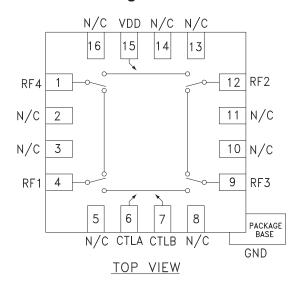
- Test Instrumentation
- Fiber Optics & Broadband Telecom
- Basestation Infrastructure
- Microwave Radio & VSAT
- Military Radios, Radar, & ECM

Features

High Isolation: 40 ~ 45 dB thru 6 GHz Low Insertion Loss: 1.2 dB@ 6 GHz

Non-Reflective Design 3 x 3 mm SMT Package

Functional Diagram



General Description

The HMC427LP3 & HMC427LP3E are low loss broadband positive control transfer switches in leadless surface mount packages. Covering DC to 8 GHz, this switch offers high isolation and low insertion loss. The switch operates using a positive control voltage of 0/+5V and requires a fixed bias of +5V @ $<20~\mu\text{A}.$

* Blocking capacitors are required at ports RF1, 2, 3, & 4. Their value will determine the lowest transmission frequency.

Electrical Specifications, $T_A = +25^{\circ}$ C, With 0/+5V Control, 50 Ohm System

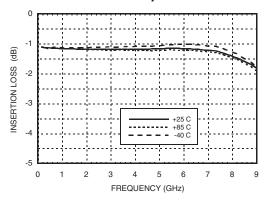
Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 6.0 GHz DC - 8.0 GHz		1.2 1.6	1.6 2.1	dB dB
Isolation	DC - 1.0 GHz DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz	42 37 33 27	48 42 38 32		dB dB dB dB
Return Loss	DC - 6.0 GHz DC - 8.0 GHz		17 15		dB dB
Input Power for 1 dB Compression	1.0 - 8.0 GHz	23	26		dBm
Input Third Order Intercept (Two-Tone Input Power= +7 dBm Each Tone, 1 MHz Tone Separation)	1.0 - 8.0 GHz	37	43		dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)	DC - 8.0 GHz		2 4		ns ns



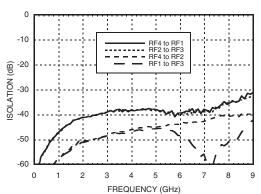
GaAs MMIC POSITIVE CONTROL TRANSFER SWITCH, DC* - 8 GHz



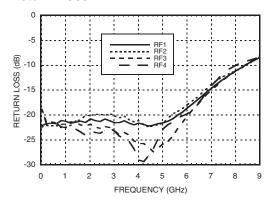
Insertion Loss vs. Temperature



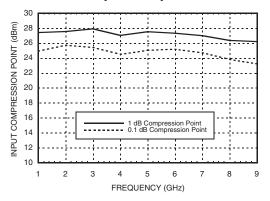
Isolation



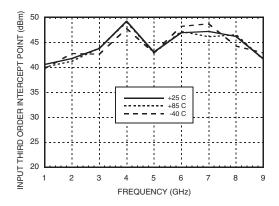
Return Loss



0.1 and 1 dB Input Compression Point



Input Third Order Intercept Point



For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com



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Absolute Maximum Ratings

Bias Voltage Range (Vdd)	+7.0 Vdc	
Control Voltage Range (A & B)	-0.5V to Vdd +1.0 Vdc	
Channel Temperature	150 °C	
Thermal Resistance	130 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
Maximum Input Power	+27 dBm	
ESD Sensitivity (HBM)	Class 1A	



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

DC blocking capacitors are required at ports RF1, 2, 3, & 4. Their value will determine the lowest transmission fre-

Bias Voltage & Current

Vdd Range = +5.0 Vdc ± 10 %			
Vdd Idd (Typ.) (Vdc) (μA)		ldd (Max.) (μΑ)	
+5.0	5	10	

Control Voltages

	State	Bias Condition	
	Low	0 to +0.2 Vdc @ 5 μA Typical	
High Vdd ± 0.2 Vdc @		Vdd ± 0.2 Vdc @ 5 μA Typical	

Truth Table

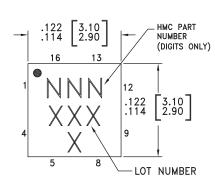
Contro	ol Input	Signal Path State			
А	В	RF4 to RF2	RF1 to RF3	RF4 to RF1	RF2 to RF3
Low	High	On	On	Off	Off
High	Low	Off	Off	On	On

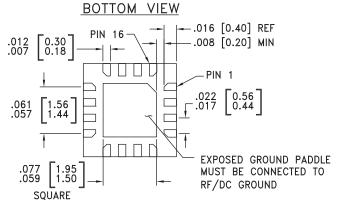
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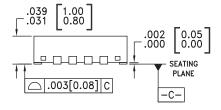


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Outline Drawing







- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC427LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	427 XXXX
HMC427LP3E	427LP3E RoHS-compliant Low Stress Injection Molded Plastic		MSL1 [2]	<u>427</u> XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



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ROHS V

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 4, 9, 12	RF4, RF1, RF3, RF2	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required.	
2, 3, 5, 8, 10, 11, 13, 14, 16	N/C	This pin should be connected to PCB RF ground to maximize isolation.	
	GND	Package bottom has exposed metal paddle that must be connected to PCB RF ground.	○ GND =
6	CTRLA	See truth table and control voltage table.	0—
7	CTRLB	See truth table and control voltage table.	
15	VDD	Supply Voltage +5V ± 10%.	0—R c = c

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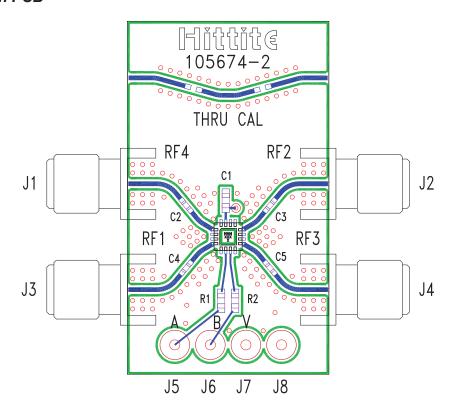
SWITCHES - SMT





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Evaluation PCB



List of Materials for Evaluation PCB 105672 [1]

Item	Description	
J1 - J4 PCB Mount SMA RF Connec		
J5 - J8 DC Pin		
C1	1000 pF Capacitor, 0603 Pkg.	
C2 - C5	100 pF Capacitor, 0402 Pkg.	
R1 - R2	100 Ohm Resistor, 0603 Pkg.	
U1	HMC427LP3 / HMC427LP3E Transfer Switch	
PCB [2] 105674 Evaluation PCB		

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

^[2] Circuit Board Material: Rogers 4350